

ATTY DKT. NO.: U.S. SERIAL NO.: FILED: APPLICANT: TITLE: REPLACEMENT SHEET

APPM/007761/IMPLANT/CONDUCTIVE/JB1
10/630,293 CONF. NO.: 9715
JULY 30, 2003
APPLIED MATERIALS, INC.
ION IMPLANTATION METHOD, SOI WAFER
MANUFACTURING METHOD AND ION IMPLANTING
SYSTEM PAGE 8 of 8